SECTION 27 05 26
GROUNDING AND BONDING FOR COMMUNICATIONS SYSTEMS

PART 1 - GENERAL

1.1 DESCRIPTION

A. This section specifies general grounding and bonding requirements of telecommunication installations for equipment operations.

B. “Grounding electrode system” refers to all electrodes required by NEC, as well as including made, supplementary, telecommunications system grounding electrodes.

C. The terms “connect” and “bond” are used interchangeably in this specification and have the same meaning.

1.2 RELATED WORK

A. Section 27 05 11, REQUIREMENTS FOR COMMUNICATIONS INSTALLATIONS: General electrical requirements and items that are common to more than one section of Division 27.

B. Section 27 10 00, STRUCTURED CABLING: Low Voltage power and lighting wiring.

.

1.3 SUBMITTALS

A. Submit in accordance with Section 27 05 11, REQUIREMENTS FOR COMMUNICATIONS INSTALLATIONS.

B. Shop Drawings:

1. Sufficient information, clearly presented, shall be included to determine compliance with drawings and specifications.
2. Include the location of system grounding electrode connections and the routing of aboveground and underground grounding electrode conductors.

C. Test Reports: Provide certified test reports of ground resistance.

D. Certifications: Two weeks prior to final inspection, submit four copies of the following to the Resident Engineer:

1. Certification that the materials and installation is in accordance with the drawings and specifications.
2. Certification, by the Contractor, that the complete installation has been properly installed and tested.

1.4 APPLICABLE PUBLICATIONS

Publications listed below (including amendments, addenda, revisions, supplements, and errata) form a part of this specification to the extent referenced. Publications are referenced in the text by the basic designation only.

A. American Society for Testing and Materials (ASTM):

B1-2001.....Standard Specification for Hard-Drawn Copper Wire

B8-2004.....Standard Specification for Concentric-Lay-Stranded Copper Conductors, Hard, Medium-Hard, or Soft

B. Institute of Electrical and Electronics Engineers, Inc. (IEEE):

81-1983.....IEEE Guide for Measuring Earth Resistivity, Ground Impedance, and Earth Surface Potentials of a Ground System

C. National Fire Protection Association (NFPA):

70-2005.....National Electrical Code (NEC)

D. Telecommunications Industry Association, (TIA)

J-STO-607-A-2002.....Commercial Building Grounding (Earthing) and Bonding Requirements for Telecommunications

E. Underwriters Laboratories, Inc. (UL):

44-2005 .....Thermoset-Insulated Wires and Cables

83-2003 .....Thermoplastic-Insulated Wires and Cables

467-2004 .....Grounding and Bonding Equipment

486A-486B-2003 .....Wire Connectors

PART 2 - PRODUCTS

2.1 GROUNDING AND BONDING CONDUCTORS

A. Equipment grounding conductors shall be UL 83 insulated stranded copper, except that sizes 6 mm² (10 AWG) and smaller shall be solid copper. Insulation color shall be continuous green for all equipment grounding conductors, except that wire sizes 25 mm² (4 AWG) and larger shall be permitted to be identified per NEC.

B. Bonding conductors shall be ASTM B8 bare stranded copper, except that sizes 6 mm² (10 AWG) and smaller shall be ASTM B1 solid bare copper wire.

C. Isolated Power System: Type XHHW-2 insulation with a dielectric constant of 3.5 or less.

D. Telecom System Grounding Riser Conductor: Telecommunications Grounding Riser shall be in accordance with J STO-607A. Use a minimum 50mm² (1/0 AWG) insulated stranded copper grounding conductor unless indicated otherwise.

.

2.2 SPLICES AND TERMINATION COMPONENTS

Components shall meet or exceed UL 467 and be clearly marked with the manufacturer, catalog number, and permitted conductor size(s).

2.3 GROUND TERMINAL BLOCKS

At any equipment mounting location (e.g. backboards and hinged cover enclosures) where rack-type ground bars cannot be mounted, provide screw lug-type terminal blocks.

2.4 SPLICE CASE GROUND ACCESSORIES

Splice case grounding and bonding accessories shall be supplied by the splice case manufacturer when available. Otherwise, use 16 mm² (6 AWG) insulated ground wire with shield bonding connectors.

PART 3 - EXECUTION

3.1 GENERAL

A. Ground in accordance with the NEC, as shown on drawings, and as hereinafter specified.

B. Equipment Grounding: Metallic structures (including ductwork and building steel), enclosures, raceways, junction boxes, outlet boxes, cabinets, machine frames, and other conductive items in close proximity with electrical circuits shall be bonded and grounded.

3.2 INACCESSIBLE GROUNDING CONNECTIONS

Make grounding connections, which are buried or otherwise normally inaccessible (except connections for which periodic testing access is required) by exothermic weld.

3.3 SECONDARY EQUIPMENT AND CIRCUITS

A. Main Bonding Jumper: Bond the secondary service neutral to the ground bus in the service equipment.

B. Metallic Piping, Building Steel, and Supplemental Electrode(s):

1. Provide a grounding electrode conductor sized per NEC between the service equipment ground bus and all metallic water and gas pipe systems, building steel, and supplemental or made electrodes. Jumper insulating joints in the metallic piping. All connections to electrodes shall be made with fittings that conform to UL 467.
2. Provide a supplemental ground electrode and bond to the grounding electrode system.

F. Conduit Systems:
1. Ground all metallic conduit systems. All metallic conduit systems shall contain an equipment grounding conductor.
2. Non-metallic conduit systems shall contain an equipment grounding conductor, except that non-metallic feeder conduits which carry a grounded conductor from exterior transformers to interior or building-mounted service entrance equipment need not contain an equipment grounding conductor.
3. Conduit containing only a grounding conductor, and which is provided for mechanical protection of the conductor, shall be bonded to that conductor at the entrance and exit from the conduit.

G. Feeders and Branch Circuits: Install equipment grounding conductors with all feeders and power and lighting branch circuits.

H. Boxes:
1. Bond the equipment grounding conductor to each pullbox, junction box, outlet box, device box, cabinets, and other enclosures through which the conductor passes (except for special grounding systems for intensive care units and other critical units shown).
2. Provide lugs in each box and enclosure for equipment grounding conductor termination.
3. Provide ground bars in panelboards, bolted to the housing, with sufficient lugs to terminate the equipment grounding conductors.

J. Receptacles shall not be grounded through their mounting screws. Ground with a jumper from the receptacle green ground terminal to the device box ground screw and the branch circuit equipment grounding conductor.

3.4 CORROSION INHIBITORS

When making ground and ground bonding connections, apply a corrosion inhibitor to all contact surfaces. Use corrosion inhibitor appropriate for protecting a connection between the metals used.

3.5 CONDUCTIVE PIPING

A. Bond all conductive piping systems, interior and exterior, to the building to the grounding electrode system. Bonding connections shall be made as close as practical to the equipment ground bus.

B. In operating rooms and at intensive care and coronary care type beds, bond the gases and suction piping, at the outlets, directly to the room or patient ground bus.

3.6 TELECOMMUNICATIONS SYSTEM

A. Bond telecommunications system grounding equipment to the electrical grounding electrode system.

B. Furnish and install all wire and hardware required to properly ground, bond and connect communications raceway, cable tray, metallic cable shields, and equipment to a ground source.

C. Ground bonding jumpers shall be continuous with no splices. Use the shortest length of bonding jumper possible.

D. Provide ground paths that are permanent and continuous with a resistance of 1 ohm or less from raceway, cable tray, and equipment connections to the building grounding electrode. The resistance across individual bonding connections shall be 10 milli ohms or less.

E. Below-Grade Grounding Connections: When making exothermic welds, wire brush or file the point of contact to a bare metal surface. Use exothermic welding cartridges and molds in accordance with the manufacturer’s recommendations. After welds have been made and cooled, brush slag from the weld area and thoroughly cleaned the joint area. Notify the Resident Engineer prior to backfilling any ground connections.

F. Above-Grade Grounding Connections: When making bolted or screwed connections to attach bonding jumpers, remove paint to expose the entire contact surface by grinding where necessary; thoroughly clean all connector, plate and other contact surfaces; and apply an appropriate corrosion inhibitor to all surfaces before joining.

G. Bonding Jumpers:

1. Use insulated ground wire of the size and type shown on the Drawings or use a minimum of 16 mm^2 (6 AWG) insulated copper wire.

2. Assemble bonding jumpers using insulated ground wire terminated with compression connectors.
3. Use compression connectors of proper size for conductors specified. Use connector manufacturer’s compression tool.

H. Bonding Jumper Fasteners:
1. Conduit: Fasten bonding jumpers using screw lugs on grounding bushings or conduit strut clamps, or the clamp pads on push-type conduit fasteners. When screw lug connection to a conduit strut clamp is not possible, fasten the plain end of a bonding jumper wire by slipping the plain end under the conduit strut clamp pad; tighten the clamp screw firmly. Where appropriate, use zinc-plated external tooth lockwashers.
2. Wireway and Cable Tray: Fasten bonding jumpers using zinc-plated bolts, external tooth lockwashers, and nuts. Install protective cover, e.g., zinc-plated acorn nuts on any bolts extending into wireway or cable tray to prevent cable damage.
3. Ground Plates and Busbars: Fasten bonding jumpers using two-hole compression lugs. Use tin-plated copper or copper alloy bolts, external tooth lockwashers, and nuts.
4. Unistrut and Raised Floor Stringers: Fasten bonding jumpers using zinc-plated, self-drill screws and external tooth lockwashers.

3.7 COMMUNICATIONS CABLE GROUNDING

A. Bond all metallic cable sheaths in multipair communications cables together at each splicing and/or terminating location to provide 100 percent metallic sheath continuity throughout the communications distribution system.
1. At terminal points, install a cable shield bonding connector provide a screw stud connection for ground wire. Use a bonding jumper to connect the cable shield connector to an appropriate ground source like the rack or cabinet ground bar.
2. Bond all metallic cable shields together within splice closures using cable shield bonding connectors or the splice case grounding and bonding accessories provided by the splice case manufacturer. When an external ground connection is provided as part of splice closure, connect to an approved ground source and all other metallic components and equipment at that location.

3.8 COMMUNCIATIONS RACEWAY GROUNDING

A. Conduit: Use insulated 16 mm² (6 AWG) bonding jumpers to ground metallic conduit at each end and to bond at all intermediate metallic enclosures.

B. Wireway: use insulated 16 mm² (6 AWG) bonding jumpers to ground or bond metallic wireway at each end at all intermediate metallic enclosures and across all section junctions.

C. Cable Tray Systems: Use insulated 16 mm² (6 AWG) bonding jumpers to ground cable tray to column-mounted building ground plates (pads) at each end and approximately every 16 meters (50 feet).

- - - E N D - - -